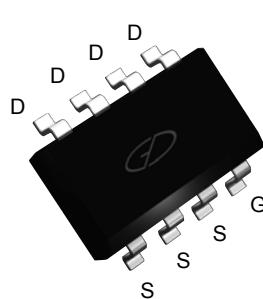
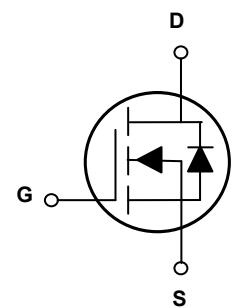


### Main Product Characteristics

$V_{DS}$	30V
$R_{DS(ON)}$	12mΩ
$I_D$	10A



SOP-8



Schematic Diagram

### Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



### Description

The SSFQ3910 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

### Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current – Continuous ( $T_C=25^\circ\text{C}$ )	$I_D$	10	A
Drain Current – Continuous ( $T_C=100^\circ\text{C}$ )		6.3	A
Drain Current – Pulsed <sup>1</sup>	$I_{DM}$	40	A
Single Pulse Avalanche Energy <sup>2</sup>	$E_{AS}$	13	mJ
Single Pulse Avalanche Current <sup>2</sup>	$I_{AS}$	16	A
Power Dissipation ( $T_C=25^\circ\text{C}$ )	$P_D$	2.1	W
Power Dissipation – Derate above $25^\circ\text{C}$		0.017	W/ $^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 to +150	$^\circ\text{C}$
Operating Junction Temperature Range	$T_J$	-55 to +150	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to Ambient	$R_{JA}$	---	60	$^\circ\text{C}/\text{W}$

## Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=250\mu\text{A}$	30	---	---	V
$\text{BV}_{\text{DSS}}$ Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Reference to $25^\circ\text{C}$ , $I_{\text{D}}=1\text{mA}$	---	0.04	---	$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	$I_{\text{DS}}^{\text{SS}}$	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
Gate-Source Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=10\text{A}$	---	9.5	12	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=5\text{A}$	---	13	18	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}$ , $I_{\text{D}}=250\mu\text{A}$	1.2	1.8	2.5	V
$V_{\text{GS}(\text{th})}$ Temperature Coefficient	$\Delta V_{\text{GS}(\text{th})}$		---	-4	---	$\text{mV}/^\circ\text{C}$
Forward Transconductance	$g_{\text{fs}}$	$V_{\text{DS}}=10\text{V}$ , $I_{\text{D}}=3\text{A}$	---	6	---	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>3,4</sup>	$Q_g$	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=5\text{A}$	---	7.4	12	nC
Gate-Source Charge <sup>3,4</sup>	$Q_{\text{gs}}$		---	2.3	5	
Gate-Drain Charge <sup>3,4</sup>	$Q_{\text{gd}}$		---	3	6	
Turn-On Delay Time <sup>3,4</sup>	$T_{\text{d}(\text{on})}$	$V_{\text{DD}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_{\text{G}}=6\Omega$ $I_{\text{D}}=1\text{A}$	---	3.8	7	nS
Rise Time <sup>3,4</sup>	$T_r$		---	10	19	
Turn-Off Delay Time <sup>3,4</sup>	$T_{\text{d}(\text{off})}$		---	22	42	
Fall Time <sup>3,4</sup>	$T_f$		---	6.6	13	
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	620	900	pF
Output Capacitance	$C_{\text{oss}}$		---	85	125	
Reverse Transfer Capacitance	$C_{\text{rss}}$		---	60	90	
Gate Resistance	$R_g$	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $F=1\text{MHz}$	---	2.8	5.6	$\Omega$
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	$I_s$	$V_G=V_D=0\text{V}$ , Force Current	---	---	10	A
Pulsed Source Current	$I_{\text{SM}}$		---	---	40	A
Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V

Note:

- Repetitive Rating: Pulsed width limited by maximum junction temperature.
- $V_{\text{DD}}=25\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{\text{AS}}=16\text{A}$ ,  $R_g=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
- The data tested by pulsed, pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- Essentially independent of operating temperature.

## Typical Electrical and Thermal Characteristic Curves

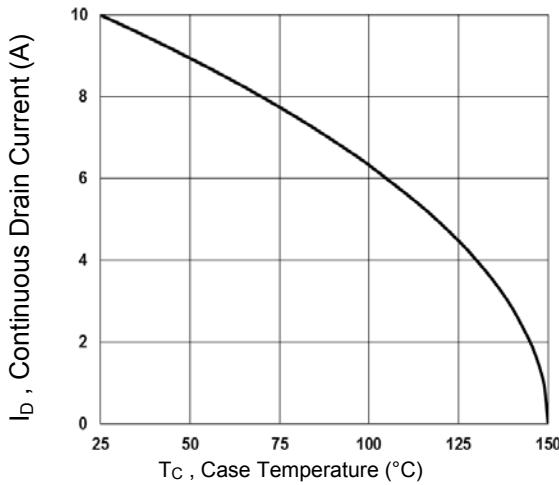


Fig.1 Continuous Drain Current vs. T<sub>c</sub>

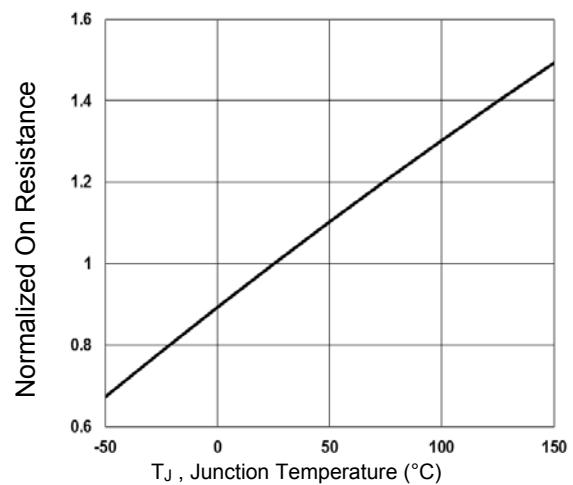


Fig.2 Normalized R<sub>DS(ON)</sub> vs. T<sub>j</sub>

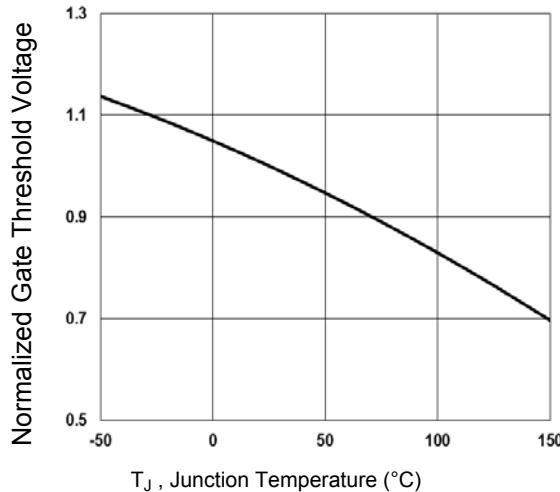


Fig.3 Normalized V<sub>th</sub> vs. T<sub>j</sub>

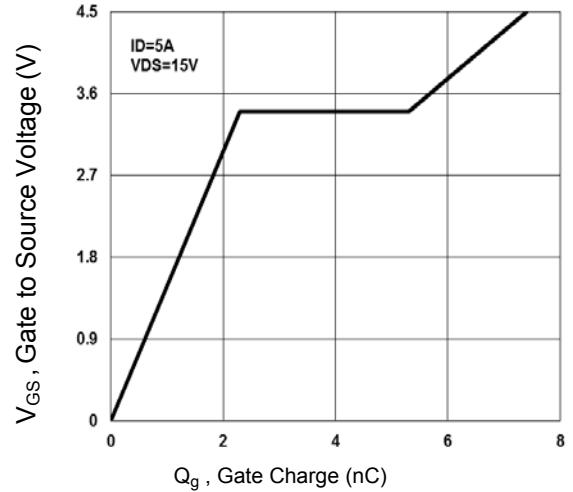


Fig.4 Gate Charge Waveform

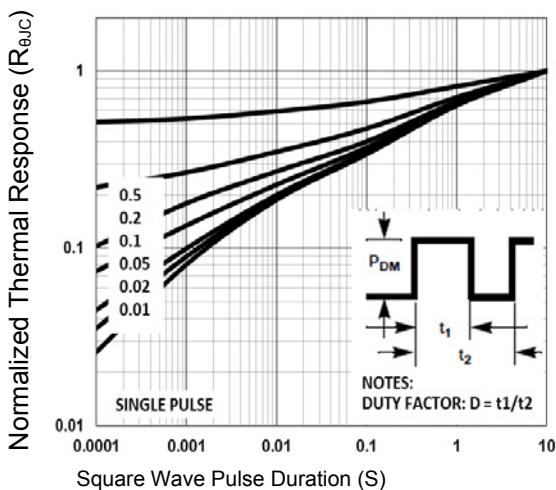


Fig.5 Normalized Transient Impedance

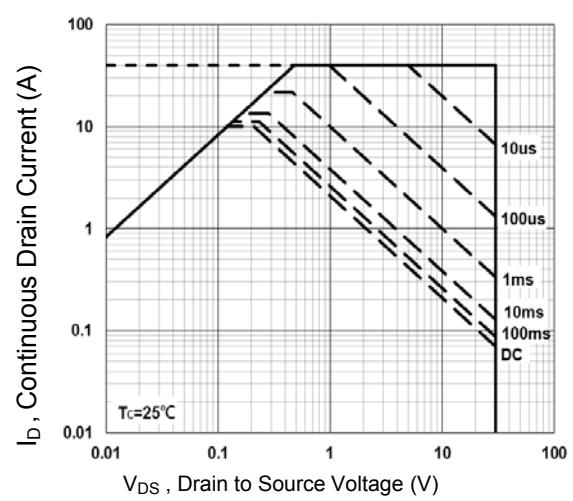
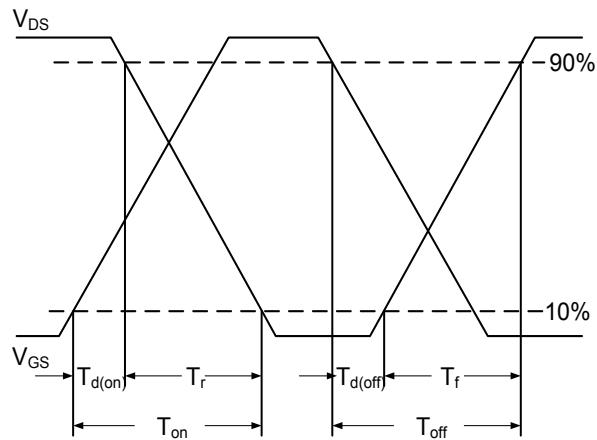
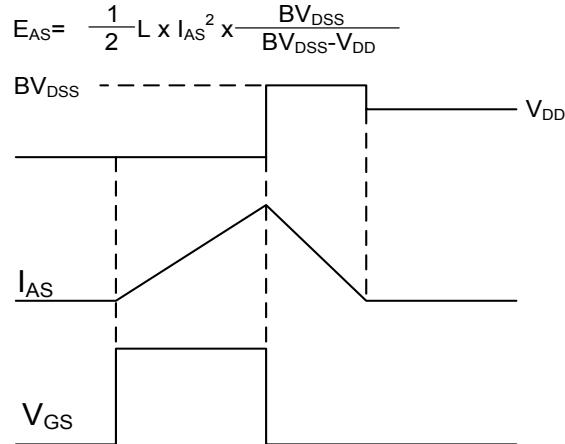


Fig.6 Maximum Safe Operation Area

## Typical Electrical and Thermal Characteristic Curves



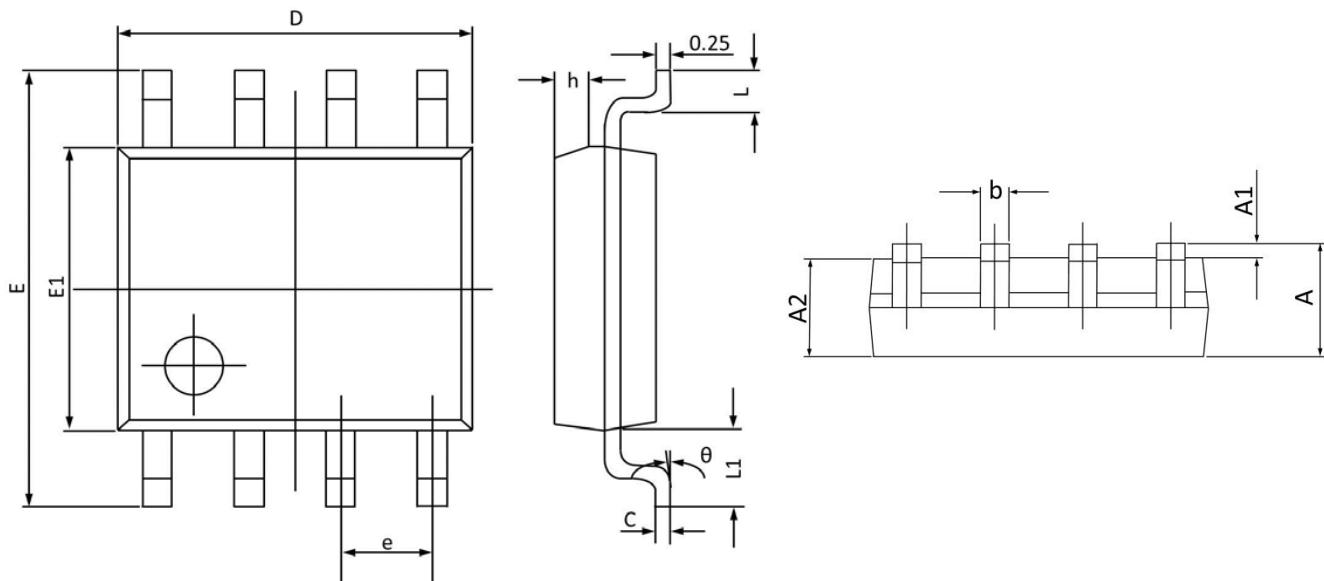
**Fig.7** Switching Time Waveform



**Fig.8**  $E_{AS}$  Waveform

## Package Outline Dimensions

**SOP-8**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.068
A1	0.100	0.250	0.004	0.009
A2	1.300	1.500	0.052	0.059
A3	0.600	0.700	0.024	0.027
b	0.390	0.480	0.016	0.018
c	0.210	0.260	0.009	0.010
D	4.700	5.100	0.186	0.200
E	5.800	6.200	0.229	0.244
E1	3.700	4.100	0.146	0.161
e	1.270(BSC)		0.050(BSC)	
h	0.250	0.500	0.010	0.019
L	0.500	0.800	0.019	0.031
L1	1.050(BSC)		0.041(BSC)	
θ	0°	8°	0°	8°

## Order Information

Device	Package	Marking Code	Carrier	Quantity	HSF Status
SSFQ3910	SOP-8	DS3910	Tape & Reel	3,000/Reel	RoHS Compliant